

N-channel 30 V 1.5 m Ω logic level MOSFET in LFPAK

Rev. 01 — 9 April 2010

Product data sheet

1. Product profile

1.1 General description

Logic level N-channel MOSFET in LFPAK package qualified to 175 °C. This product is designed and qualified for use in a wide range of industrial, communications and domestic equipment.

1.2 Features and benefits

- Advanced TrenchMOS provides low RDSon and low gate charge
- High efficiency gains in switching power convertors

1.3 Applications

- DC-to-DC converters
- Lithium-ion battery protection
- Load switching

1.4 Quick reference data

- Improved mechanical and thermal characteristics
- LFPAK provides maximum power density in a Power SO8 package
- Motor control
- Server power supplies

Table 1.	Quick reference da	ta					
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V_{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C		-	-	30	V
I _D	drain current	$T_{mb} = 25 \text{ °C}; V_{GS} = 10 \text{ V}; \text{ see}$ Figure 1	<u>[1]</u>	-	-	100	A
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 2</u>		-	-	109	W
Tj	junction temperature			-55	-	175	°C
Static cha	aracteristics						
R _{DSon}	drain-source on-state	$V_{GS} = 10 \text{ V}; I_D = 15 \text{ A};$ T _j = 100 °C; see <u>Figure 14</u>		-	-	2.4	mΩ
	resistance	V_{GS} = 10 V; I _D = 15 A; T _j = 25 °C		-	1.3	1.5	mΩ
Dynamic	characteristics						
Q _{GD}	gate-drain charge	$\label{eq:V_GS} \begin{array}{l} V_{GS} = 4.5 \text{ V}; \text{ I}_{D} = 10 \text{ A}; \\ V_{DS} = 12 \text{ V}; \text{ see } \underline{\text{Figure 15}}; \text{ see } \\ \underline{\text{Figure 16}} \end{array}$		-	8.7	-	nC



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Table 1.	Quick reference da	tacontinued				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Q _{G(tot)}	total gate charge	$\label{eq:VGS} \begin{array}{l} V_{GS} = 4.5 \text{ V}; \text{ I}_{D} = 10 \text{ A}; \\ V_{DS} = 12 \text{ V}; \text{ see } \underline{\text{Figure } 15} \end{array}$	-	36.2	-	nC
Avalanch	e ruggedness					
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	$ \begin{split} V_{GS} &= 10 \text{ V}; \ T_{j(init)} = 25 \ ^{\circ}\text{C}; \\ I_{D} &= 100 \text{ A}; \ V_{sup} \leq 30 \text{ V}; \\ R_{GS} &= 50 \ \Omega; \ unclamped \end{split} $	-	-	241	mJ

[1] Continuous current is limited by package.

2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S	source		_
2	S	source	mb	
3	S	source		
4	G	gate	q	
mb	D	mounting base; connected to drain	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	mbb076 S
			SOT669 (LFPAK)	

3. Ordering information

Table 3.	Ordering in	formation		
Type number Package		Package		
		Name	Description	Version
PSMN1R5-	30YL	LFPAK	plastic single-ended surface-mounted package (LFPAK); 4 leads	SOT669

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4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C		-	-	30	V
V _{DGR}	drain-gate voltage	$T_j \ge 25 \text{ °C}; T_j \le 175 \text{ °C}; R_{GS} = 20 \text{ k}\Omega$		-	-	30	V
V _{GS}	gate-source voltage			-20	-	20	V
I _D	drain current	V_{GS} = 10 V; T_{mb} = 100 °C; see Figure 1	<u>[1]</u>	-	-	100	А
		V_{GS} = 10 V; T_{mb} = 25 °C; see <u>Figure 1</u>	<u>[1]</u>	-	-	100	А
I _{DM}	peak drain current	t _p ≤ 10 μs; pulsed; T _{mb} = 25 °C; see <u>Figure 4</u>		-	-	790	A
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 2</u>		-	-	109	W
T _{stg}	storage temperature			-55	-	175	°C
Tj	junction temperature			-55	-	175	°C
Source-drai	in diode						
I _S	source current	T _{mb} = 25 °C	[1]	-	-	100	А
I _{SM}	peak source current	$t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$		-	-	790	А
Avalanche I	ruggedness						
E _{DS(AL)R}	repetitive drain-source avalanche energy	see Figure 3	[2][3][4]	-	-	-	J
$E_{DS(AL)S}$	non-repetitive drain-source avalanche energy	$ \begin{array}{l} V_{GS} = 10 \text{ V}; \text{T}_{j(init)} = 25 \text{ °C}; \text{I}_{D} = 100 \text{ A}; \\ V_{sup} \leq 30 \text{ V}; \text{R}_{GS} = 50 \Omega; \text{ unclamped} \end{array} $		-	-	241	mJ

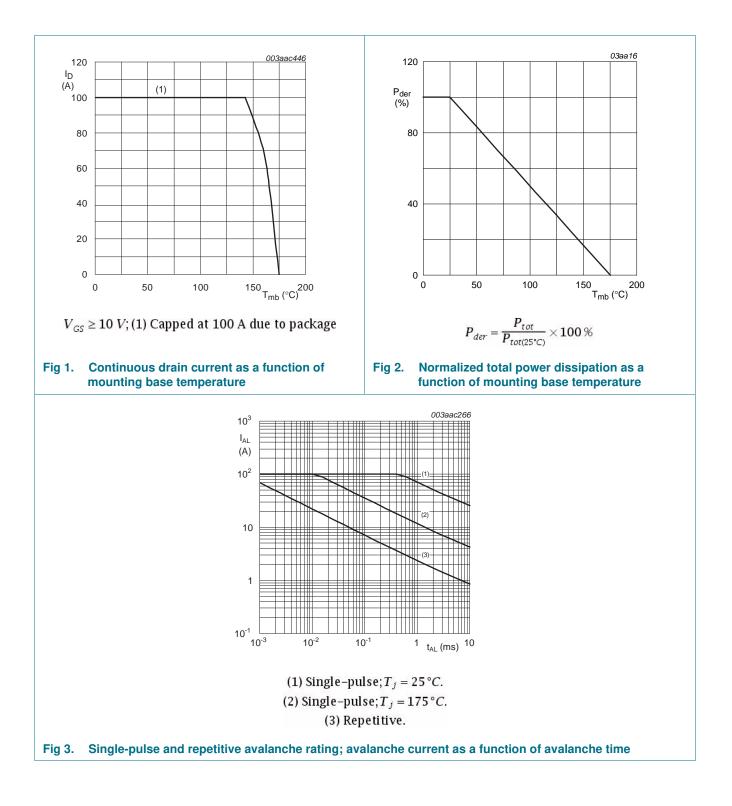
[1] Continuous current is limited by package.

[2] Single-pulse avalanche rating limited by maximum junction temperature of 175 °C.

[3] Repetitive avalanche rating limited by average junction temperature of 170 °C.

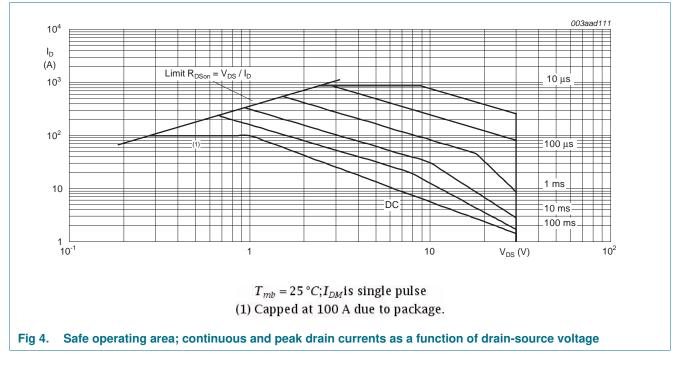
[4] Refer to application note AN10273 for further information.

PSMN1R5-30YL



PSMN1R5-30YL

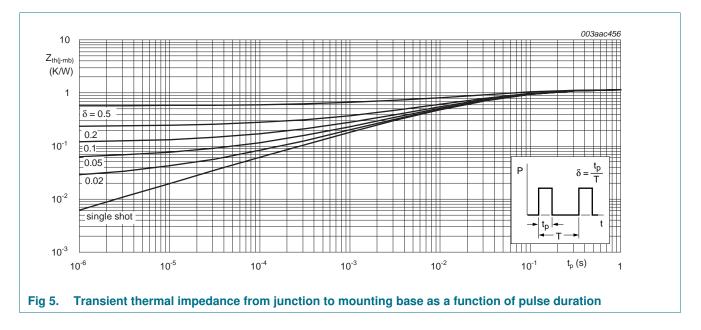
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5. Thermal characteristics

Table 5. Thermal cha	aracteristics
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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th}(j\text{-mb})}$	thermal resistance from junction to mounting base	see <u>Figure 5</u>	-	0.5	1.1	K/W



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6. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	cteristics					
V _{(BR)DSS}	drain-source breakdown voltage	I_D = 20 A; V_{GS} = 0 V; T_j = 25 °C; t_{av} = 100 ns	35	-	-	V
		$I_D = 250 \ \mu A; \ V_{GS} = 0 \ V; \ T_j = 25 \ ^\circ C$	30	-	-	V
		$I_D = 250 \ \mu A; V_{GS} = 0 \ V; T_j = -55 \ ^{\circ}C$	27	-	-	V
V _{GS(th)}	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C};$ see Figure 12; see Figure 13	1.3	1.7	2.15	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 150 \text{ °C};$ see <u>Figure 13</u>	0.65	-	-	V
		$\label{eq:ID} \begin{split} I_D = 1 \mbox{ mA; } V_{DS} = V_{GS}; T_j = -55 \mbox{ °C}; \\ see Figure \mbox{ 13} \end{split}$	-	-	2.45	V
I _{DSS}	drain leakage current	$V_{DS} = 30 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	-	1	μA
		$V_{DS} = 30 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 150 \text{ °C}$	-	-	100	μA
I _{GSS}	gate leakage current	V_{GS} = 16 V; V_{DS} = 0 V; T_j = 25 °C	-	-	100	nA
		V_{GS} = -16 V; V_{DS} = 0 V; T_j = 25 °C	-	-	100	nA
R _{DSon}	drain-source on-state	V_{GS} = 4.5 V; I _D = 15 A; T _j = 25 °C	-	1.8	1.9	mΩ
resistance	resistance	V _{GS} = 10 V; I _D = 15 A; T _j = 150 °C; see <u>Figure 14</u>	-	-	2.8	mΩ
		V _{GS} = 10 V; I _D = 15 A; T _j = 100 °C; see <u>Figure 14</u>	-	-	2.4	mΩ
		V_{GS} = 10 V; I _D = 15 A; T _j = 25 °C	-	1.3	1.5	mΩ
R _G	gate resistance	f = 1 MHz	-	0.77	1.5	Ω
Dynamic ch	aracteristics					
Q _{G(tot)}	total gate charge	$I_D = 10 \text{ A}; V_{DS} = 12 \text{ V}; V_{GS} = 10 \text{ V};$ see <u>Figure 15</u> ; see <u>Figure 16</u>	-	77.9	-	nC
		$I_{D} = 0 \text{ A}; V_{DS} = 0 \text{V}; V_{GS} = 10 \text{V}$	-	70	-	nC
		$I_D = 10 \text{ A}; V_{DS} = 12 \text{ V}; V_{GS} = 4.5 \text{ V}; \text{ see } \frac{\text{Figure } 15}{100000000000000000000000000000000000$	-	36.2	-	nC
Q _{GS}	gate-source charge	$I_D = 10 \text{ A}; V_{DS} = 12 \text{ V}; V_{GS} = 4.5 \text{ V};$	-	11.6	-	nC
Q _{GS(th)}	pre-threshold gate-source charge	see <u>Figure 15;</u> see <u>Figure 16</u>	-	8	-	nC
Q _{GS(th-pl)}	post-threshold gate-source charge		-	3.6	-	nC
Q _{GD}	gate-drain charge		-	8.7	-	nC
V _{GS(pl)}	gate-source plateau voltage	V _{DS} = 12 V; see <u>Figure 15;</u> see <u>Figure 16</u>	-	2.34	-	V
C _{iss}	input capacitance	$V_{DS} = 12 \text{ V}; V_{GS} = 0 \text{ V}; f = 1 \text{ MHz};$	-	5057	-	pF
C _{oss}	output capacitance	$T_j = 25 \text{ °C}; \text{ see } Figure 17$	-	1082	-	pF
C _{rss}	reverse transfer		-	398	-	pF

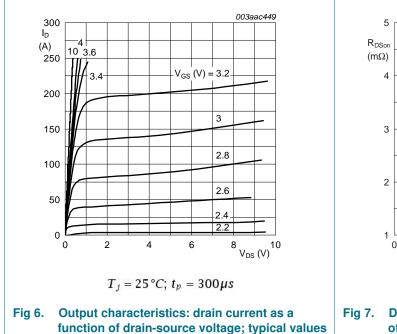
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Table 6. Characteristics ...continued

Tested to JEDEC standards where applicable.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t _{d(on)}	turn-on delay time	$V_{DS} = 12 \; V; \; R_L = 0.5 \; \Omega; \; V_{GS} = 4.5 \; V; \;$	-	46	-	ns
t _r	rise time	$R_{G(ext)} = 4.7 \ \Omega$	-	72	-	ns
t _{d(off)}	turn-off delay time		-	76	-	ns
t _f	fall time		-	34	-	ns
Source-dra	in diode					
V_{SD}	source-drain voltage	I _S = 25 A; V _{GS} = 0 V; T _j = 25 °C; see <u>Figure 18</u>	-	0.78	1.2	V
t _{rr}	reverse recovery time	$I_{S} = 20 \text{ A}; dI_{S}/dt = -100 \text{ A}/\mu s; V_{GS} = 0 \text{ V};$	-	45	-	ns
Q _r	recovered charge	$V_{DS} = 20 V$	-	56	-	nC



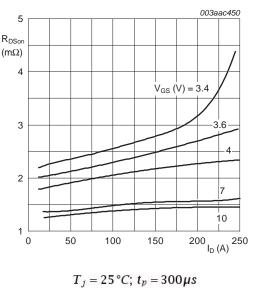
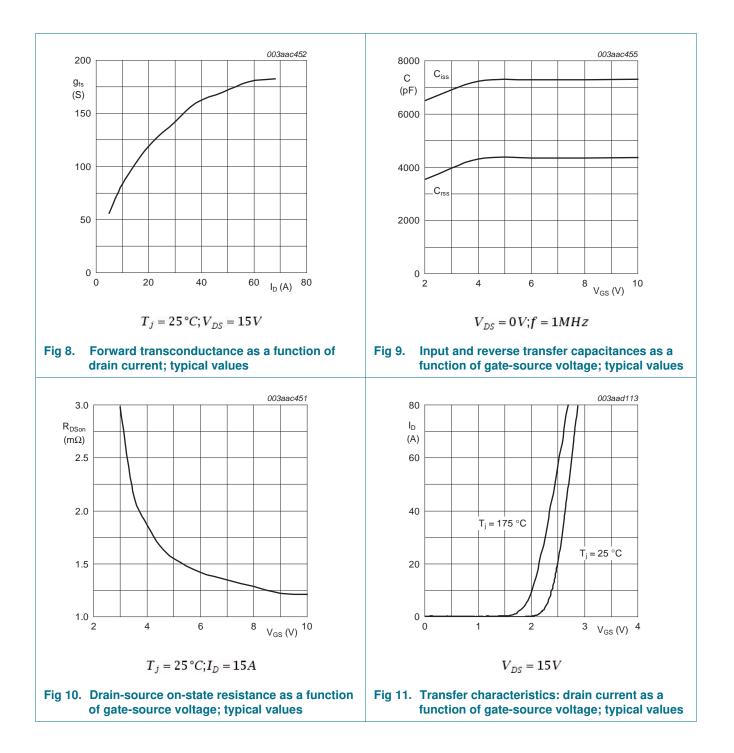
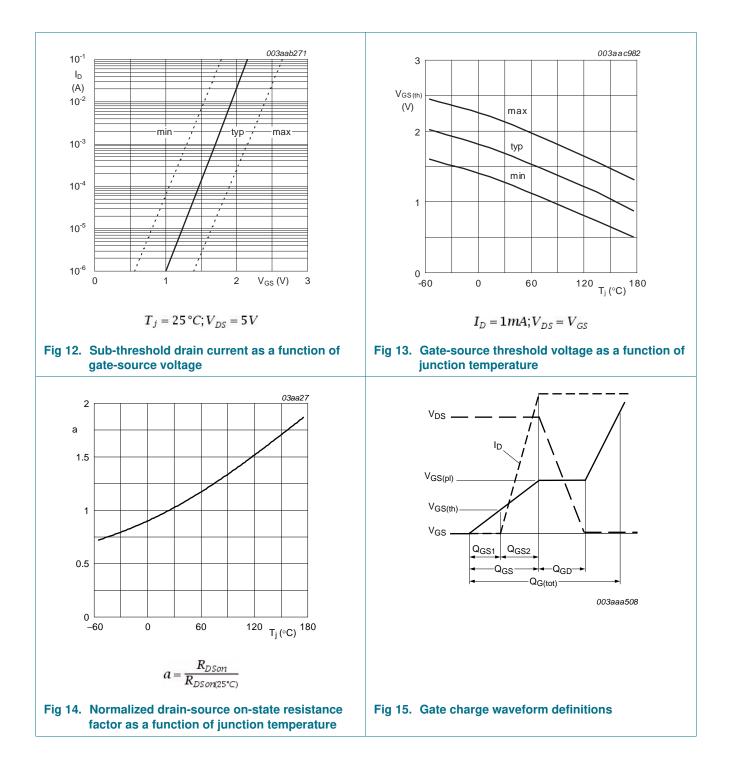


Fig 7. Drain-source on-state resistance as a function of drain current; typical values

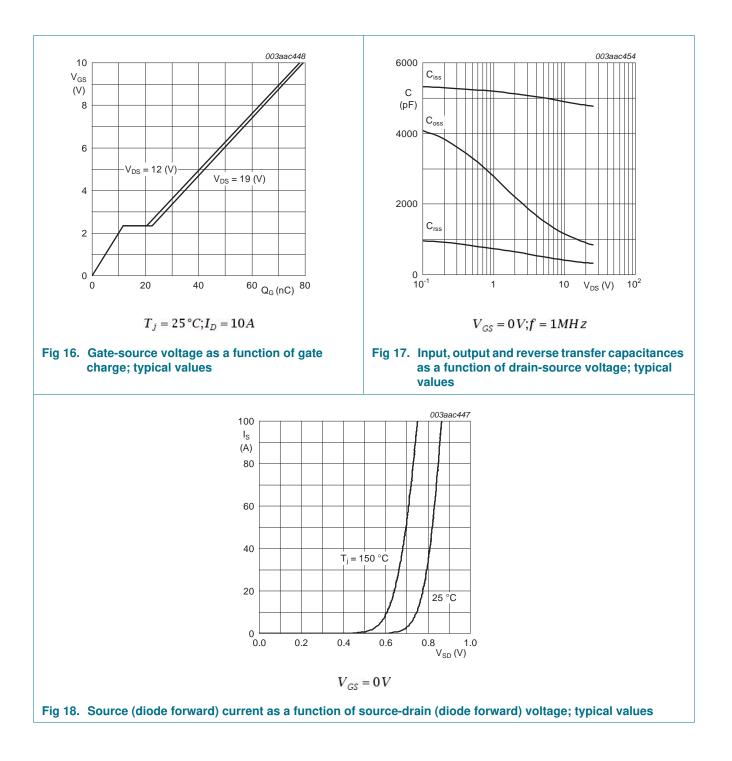
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7. Package outline

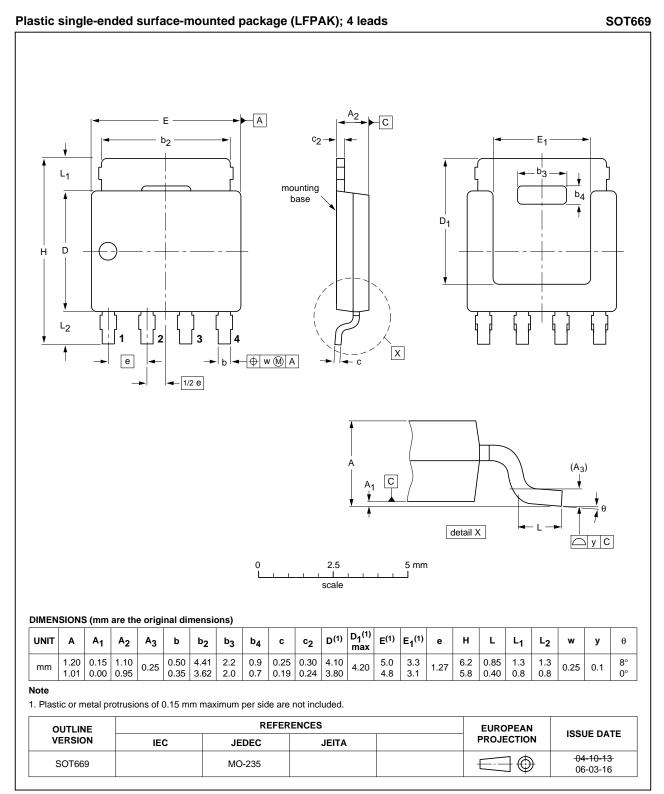


Fig 19. Package outline SOT669 (LFPAK)

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PSMN1R5-30YL

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8. Revision history

Table 7. Revision his	tory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PSMN1R5-30YL_1	20100409	Product data sheet	-	-

9. Legal information

9.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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